## zeptoSMDC Series Surface Mount





## **Web Resources**



Download ECAD models, order samples, and find technical recources at www.littelfuse.com

#### **Agency Approvals**

Agency	Agency File Number
<b>7U</b> °	E74889
$\triangle$	50517757

### **Description**

Littelfuse zeptoSMDC Series PPTC is developed for overcurrent and overtemperature protection in mobile applications. It works to protect battery management ICs and fuel auges.

#### **Features**

- Maximum electrical rating: 13 VDC
- Short circuit current: 82~200mA
- Small footprint 0201 size
- RoHS compliant
- ISO/TS 16949 certified
- Resets to normal operation after fault is cleared
- Help protect battery monitor IC from electrical over-stress
- Save space due to small footprint

#### **Applications**

- Smartphones and Tablets
- Notebook PC
- e-Readers
- Portable medical equipment
- Mobile point of sale
- Wearables
- Smartwatches
- Wireless speakers
- Portable game players

#### **Electrical Characteristics**

		esistance @ 25°C	V <sub>MAX</sub> <sup>2</sup>	I <sub>MAX</sub> <sup>3</sup>	Trip	Hold Current⁴	Time to Trip⁵		Post Process Resistance <sup>6</sup>	
Part Number	Min¹	Max	(Vdc)	(mA)	Temperature °C TYP	(mA) @ 25°C	Current (mA)	Time (ms) Max	ohms @ -20°C Min	ohms @ 60°C Max
zeptoSMDC0011F	10	80	13	82	125	11	80	20	68	290
zeptoSMDC0015F	10	60	13	200	125	15	80	20	28	150

#### Notes:

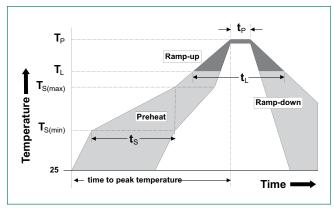
- 1. Rmin = Minimum resistance of device in initial (un-soldered) state
- 2. Vmax = Maximum voltage device can withstand without damage at rated current (Imax)
- 3. Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax)
- 4. Ihold = Hold current: maximum current device will pass without tripping in 25°C still air. Values specified using PCB's with 0.004" x 1.0 ounce copper traces
  5. Time to trip values specified using PCB's with 0.004" x 1.0 ounce copper traces
- 6. With LOCTITE ECCOBOND UF 3915, curing condition: 140°C/20mins, resistance is measured 12 hours post coating curing process



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#### **Soldering Parameters**

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<b>Profile Feature</b>	Pb-Free Assembly	
Average Ramp-Up	1~3 °C/second max.	
	Temperature Min. (Ts <sub>min</sub> )	130 °C
Preheat:	Temperature Max. (Ts <sub>max</sub> )	180 °C
	Time Min. to Max (ts)	90 – 110 seconds
Ts <sub>max</sub> to T <sub>L</sub> Ramp-up	≤2 °C/seconds max.	
Reflow	Temperature (T <sub>L</sub> ) (Liquidus)	217 °C
	Time (t <sub>L</sub> )	60~70 seconds
Peak Temperature (	240 °C	
Time within 3°C of	35 seconds	
Ramp-down Rate	2~4 °C/seconds	
Time 25°C to peak	300 seconds max.	



- All temperature refer to topside of the package, measured on the package body surface.
- If reflow temperature exceeds the recommended profile, devices may not meet the performance requirements.
- Recommended reflow methods:IR, vapor phase oven, hot air oven.
- Customer should validate that the solder paste amount and reflow recommendations to meet its application
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard industry methods and aqueous solvents.
- Devices can be reworked using the standard industry practices (avoid contact to
- the device

#### **Physical Specifications**

Terminal Material	Solder-Plated Copper (Solder Material: NiAu)
Lead Solderability	Meets EIA Specification RS186-9E, ANSI/J- STD- 002B, Test S

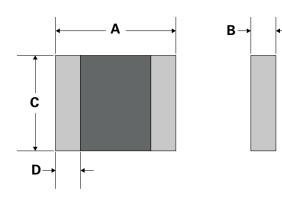
#### **Environmental Specifications**

Operating Temperature	-20°C to 60°C
Passive Aging	+85°C, 1000 hours -25% typical resistance change
Humidity Aging	+65°C, 90%,R.H.,100 hours -/+15% typical resistance change
Thermal Shock	MILSTD-202, Method 107G -33% typical resistance change -40°C to 85°C (20 times)
Vibration	MIL-STD-202, Method 204 Condition A No change
Moisture Sensitivity Level	Level 2a, J-STD-020

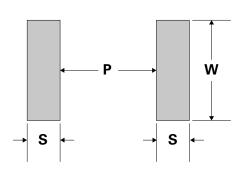


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#### **Physical Dimensions**



#### **Solder Pad Layout**



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Part Number	Min	Max	Min	Max	Min	Max	Min	Max
zeptoSMDC0011F	0.55 (0.022)	0.65 (0.026)	-	0.40 (0.016)	0.40 (0.016)	0.50 (0.020)	0.10 (0.004)	0.25 (0.010)
zeptoSMDC0015F	0.55 (0.022)	0.65 (0.026)	-	0.40 (0.016)	0.40 (0.016)	0.50 (0.020)	0.10 (0.004)	0.25 (0.010)

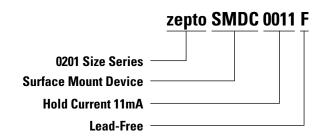
#### **Packaging**

Part Number	Ordering	Tape & Reel Quantity	ty Minimum Orgder Quantity	Recommended Pad Layout Figures [mm(in)]			
Fart Number Orden	Ordering	iape & neel Qualitity		Dimension W (Nom)	Dimension S (Nom)	Dimension P (Nom)	
zeptoSMDC0011F	RF5005-000	15,000	15,000	0.45 (0.0178)	0.325 (0.013)	0.250 (0.010)	
zeptoSMDC0015F	RF5006-000	15,000	15,000	0.45 (0.0178)	0.325 (0.013)	0.250 (0.010)	

#### Warning

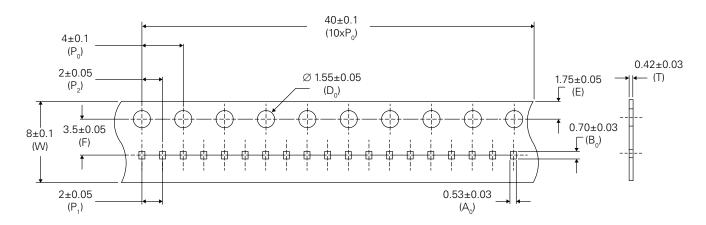
- Electrical performance of the device can differ according to installation conditions. Users should independently evaluate the suitability of the device under the actual application conditions.
- Operation beyond maximum ratings may result indevice damage.
- Exposure to silicon-based oils, solvents, electrolytes, acids, or similar materials can adversely affect device performance.
- The device undergoes thermal expansion during fault conditions. It should be provided with adequate space to allow expansion and should be protected against mechanical stress.
- Consult with Littelfuse if the device will experience thermal process other than reflow onto PCB board, such as molding or hand soldering.

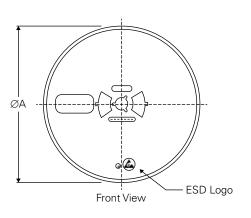
#### **Part Ordering Number System**

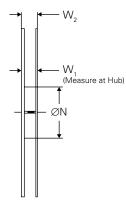




#### **Tape and Reel Specifications**







All dimensions in mm				
W	8 ±0.1			
$P_{0}$	4 ± 0.1			
P <sub>1</sub>	2 ± 0.05			
$P_2$	$2 \pm 0.05$			
$\mathbf{A_{o}}$	$0.53 \pm 0.03$			
B <sub>o</sub>	$0.70 \pm 0.03$			
$D_{o}$	1.55 ± 0.05			
F	$3.5 \pm 0.05$			
E	1.75 ± 0.05			
Т	$0.42 \pm 0.03$			
Α	178.0 ± 1.0			
N	$54.0 \pm 0.5$			
$W_{_1}$	$9.5 \pm 0.5$			
W <sub>2 max</sub>	15.0			

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